

Substitute Form PTO-1449 (Modified)	U.S. Department of Commerce Patent and Trademark Office	Attorney's Docket No. 07977-004002	Application No. New Continuation Application
<b>Information Disclosure Statement</b> <b>by Applicant</b> <small>(Use several sheets if necessary)</small>			
<i>JUL 22 2005</i> <i>PATENT &amp; TRADEMARKS</i>		Applicant Naoto Kusumoto et al.	
(37 CFR §1.98(b))		Filing Date June 25, 2003	Group Art Unit

### U.S. Patent Documents

Examiner Initial	Desig. ID	Document Number	Publication Date	Patentee	Class	Subclass	Filing Date If Appropriate
<i>DM</i>	AA	3,585,088	06/1971	Scwuttke et al.			
	AB	4,195,913	4/1/80	Dourte et al.			
	AC	4,475,027	10/2/84	Pressley			
	AD	5,145,808	09/1995	Sameshima et al.			
	AE	5,219,786	6/15/93	Noguchi			
	AF	5,304,357	04/1994	Sato et al.			
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	AH	5,424,244	6/13/95	Zhang, et al.			
	AI	5,432,122	07/1995	Chae			
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	AS	6,143,661	11/7/2000	Kousai, et al.			
<i>DM</i>	AT	6,358,784	03/19/2002	Zhang, et al			

### Foreign Patent Documents or Published Foreign Patent Applications

Examiner Initial	Desig. ID	Document Number	Publication Date	Country or Patent Office	Class	Subclass	Translation
<i>DM</i>	AU	ZA8306334	03/1984	China			<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
	AV	64-76715	03/1989	Japan			
	AW	1-76715	03/1989	Japan			
<i>DM</i>	AX	3-286518	12/1991	Japan			

Examiner Signature <i>Naoto Kusumoto</i>	Date Considered <i>8/05</i>
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Examiner Initial	Desig. ID	Document Number	Publication Date	Country or Patent Office	Class	Subclass	Translation <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
<i>DK</i>	AY	4-307727	10/1992	Japan	—	—	—

Other Documents (include Author, Title, Date, and Place of Publication)		
Examiner Initial	Desig. ID	Document
<i>DPR</i>	AZ	Anderson et al.; "Characterization of the substrate interface of excimer laser crystallized polysilicon"; <i>MRS Symp. Proc. 343</i> ; pp. 709; 1994
	AAA	Brotherton et al.; "Beam shape effects with EL crystallization of...a-Si"; <i>Solid State Phenomena 37-38</i> ; pp. 299-304; 1994
	ABB	Carluccio et al., "Microstructure of Polycrystalline Silicon Films Obtained by Combined Furnace and Laser Annealing", <i>Appl. Phys. Lett.</i> , Vol. 66, No. 11, pp. 1394-1396
	ACC	Caune et al.; "Combined CW laser and furnace annealing of a-Si and Ge in contact with some metals"; <i>Appl. Surf. Sci. 36</i> ; p. 597; 1989
	ADD	Hayashi et al.; "Fabrication of Low-Temperature Bottom-Gate Poly-Si TFTs on Large-Area Substrate by Linear-Beam Excimer Laser Crystallization and Ion Doping Method"; <i>IEEE IEDM</i> ; pp. 829-832; 1995
	AEE	Jhon et al.; "Crystallization of Amorphous Silicon by Excimer Laser Annealing with a Line Shape Beam Having a Gaussian Profile"; <i>Japan Journal of Applied Physics, Vol. 33</i> ; pp. 1438-1441; October 1994
	AFF	Jhon et al.; "Crystallization of a-Si by ELA with a line shape beam having a Gaussian profile"; <i>Jpn. J. Appl. Phys. 33(10B)</i> ; p. L1438; October 1994
	AGG	Kohno et al., "High Performance Poly-Si TFTs Fabricated Using Pulsed Laser Annealing and Remote Plasma CVD with Low Temperature Processing", <i>IEEE Transactions on Electron Devices</i> , Vol. 42, No. 2, pp. 251-257
	AHH	Kuriyama et al.; "Improving...ELA method for giant microelectronics"; <i>Jpn. J. Appl. Phys. 31(12B)</i> ; p. 4550; December 1992
	AII	Kuriyama et al.; "Lateral grain growth of Poly-Si films...by ELA..."; <i>Jpn. J. Appl. Phys. 32(12B)</i> ; p. 6190; December 1993
	AJJ	Okumura et al.; "Excimer laser annealed poly-Si TFT technologies"; <i>MRS Symp. Proc. 377</i> ; p. 877; April 1995
<i>DK</i>	AKK	Sweatt; "Transforming a circular laser beam into a square or trapezoid..."; <i>Optical Eng. 31(2)</i> ; p. 245; February 1992

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